

**DECLARATION AND POWER OF ATTORNEY**  
(sole inventor)

As below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name,

I believe I am the original, first and sole inventor of the subject matter which is claimed and for which a patent is sought on the invention entitled PANEL WITH SLIP-ON PROFILE, the specification of which was filed 20 , Serial No. 09/890,511 [is enclosed herewith.] I hereby state that I authorized the filing of this application.

I .A. No. PCT/EP00/01359

I .A. Filing Date: February 18, 2000

I hereby state that I have reviewed and understand the contents of the above-identified specification and claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose all information that is material to the patentability of this application in accordance with Title 37, Code of Federal Regulations, Section 1.56.

I hereby claim foreign priority benefits under Title 35, United States Code, Section 119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate for the same invention having a filing date before that of the application on which priority is claimed:

**PRIOR FOREIGN APPLICATION(S)**

299 22 649.2 DE (Number) (Country)	27 December 1999 (Day/Month/Year Filed)	Yes Priority Claimed
200 01 788.8 DE (Number) (Country)	02 February 2000 (Day/Month/Year Filed)	Yes Priority Claimed
00/01359 PCT/EP (Number) (Country)	18 February 2000 (Day/Month/Year Filed)	Yes Priority Claimed

And I hereby appoint Michael A. Cornman, Registration No. 20,672; Fritz L. Schweitzer, Jr., Registration No. 17,402; Meyer A. Gross, Registration No. 22,036; Jay A. Bondell, Esq., Registration No. 28,188; Fritz L. Schweitzer III, Registration No. 39,363; and Robert I. Pearlman, Registration No. 18,881 to prosecute this application and to transact all business in the Patent Office connected therewith, and I hereby request that all correspondence herein be directed to SCHWEITZER CORNMAN GROSS & BONDELL LLP, 292 Madison Avenue, 19<sup>th</sup> Floor, New York, New York 10017.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and, further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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Full name of inventor: Maik Moebus

Inventor's signature: Maik Moebus

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